

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1784	(multilayer\$2 with ceramic with (substrate or board)) and (cavity or cavities or opening)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:27
L2	1615	(multilayer\$2 with ceramic with (substrate or board)) and (cavity or cavities or opening) and (component or device or IC or chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:28
L3	24	(multilayer\$2 with ceramic with (substrate or board)) and (cavity or cavities or opening) and (component or device or IC or chip) and (capacit\$3 adj (layer or film))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:30
L4	13	361/301.1.ccls. and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:30
L5	6	361/301.3.ccls. and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:31
L6	159	361/306.3.ccls. and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 08:31
L7	5	("5081563"   "5103283"   "5210683"   "5272590"   "5403784").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 08:36
L8	69	("5081563").URPN.	USPAT	OR	ON	2005/06/02 08:36
L9	14	("5831810").URPN.	USPAT	OR	ON	2005/06/02 08:51
L10	0	(mulrilayer near2 substrate) and (ceramic near2 layer)	USPAT	OR	ON	2005/06/02 08:52
L11	802	(multilayer near2 substrate) and (ceramic near2 layer)	USPAT	OR	ON	2005/06/02 08:53
L12	2	("4902854"   "5012386").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 09:09
L13	28	("5650662").URPN.	USPAT	OR	ON	2005/06/02 09:09
L14	3	("4340618"   "4493856"   "4795670").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 09:23

L15	375	(multilayer adj ceramic adj substrate) and board	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 09:23
L16	195	(multilayer adj ceramic adj substrate) and board and capacit\$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 09:29
L17	199	(multilayer adj ceramic adj substrate) and board and capacit\$3	US-PGPUB; USPAT; USOCR; EPO; JPO	OR	ON	2005/06/02 09:33
L18	470	(package near2 high near2 frequency).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:40
L19	136	18 and ceramic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:35
L20	0	18 and ceramic and substraee	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:43
L21	18	("4827327"   "4875087"   "5122856"   "5264729"   "5283081"   "5400220"   "5406125"   "5483421"   "5502397"   "5510758"   "5543661"   "5639989"   "5703394"   "5832598"   "5835357"   "5869903"   "5929510"   "5932926").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 09:36
L22	960	(package adj for high adj frequency adj waves).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:45
L23	19	22 and hiroshi	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:41
L24	0	18 and substraee	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:42



L25	206	18 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:42
L26	70	18 and ceramic and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:43
L27	1823	(package adj for high adj frequency adj waves) and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:46
L28	535	(package adj for high adj frequency adj waves) and substrate and ceramic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:50
L29	43	(multilayered adj ceramic adj circuit adj board).ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:55
L30	46	(multilayered adj ceramic adj substrate) and via and capacit\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:57
L31	729	(capacit\$3 adj (layer or film)) and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:58
L32	278	(capacit\$3 adj (layer or film)) and multilayer and ceramic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 09:58
L33	151	(capacit\$3 adj (layer or film)) and multilayer and ceramic and board	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:01
L34	729	(capacit\$3 adj (layer or film)) and multilayer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:02

L35	533	(capacit\$3 adj (layer or film)) and multilayer and conduct\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:02
L36	170	(capacit\$3 adj (layer or film)) and multilayer and conduct\$3 and ground	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:02
L37	129	(capacit\$3 adj (layer or film)) and multilayer and conduct\$3 and ground and via	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:07
L38	282	361/783.ccls. and ceramic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:07
L39	82	361/783.ccls. and ceramic and cavity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:09
L40	30	361/763.ccls. and ceramic and cavity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:10
L41	2058	"361"/\$.ccls. and ceramic and cavity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:10
L42	1158	"361"/\$.ccls. and ceramic and cavity and capacit\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:11
L43	60	"361"/\$.ccls. and ceramic and cavity and (capacit\$3 adj (layer or film))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/06/02 10:11